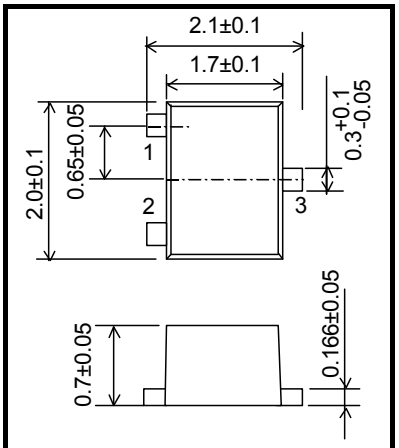
TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

SSM3J112TU

High Speed Switching Applications

- 4V drive
- Low on-resistance: R_{on} = 790mΩ (max) (@V_{GS} = −4 V)
  R_{on} = 390mΩ (max) (@V_{GS} = −10 V)

Unit: mm



1: Gate
2: Source
3: Drain

UFM

JEDEC	—
JEITA	—
TOSHIBA	2-2U1A

Weight: 6.6 mg (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-Source voltage		V_{DS}	−30	V
Gate-Source voltage		V_{GSS}	± 20	V
Drain current	DC	I_D	−1.1	A
	Pulse	I_{DP}	−2.2	
Drain power dissipation		$P_{D\ (Note\ 1)}$	800	mW
		$P_{D\ (Note\ 2)}$	500	
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board.
(25.4 mm × 25.4 mm × 0.8 mm, Cu Pad: 645 mm^2)

Note 2: Mounted on FR4 board.
(25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm^2)

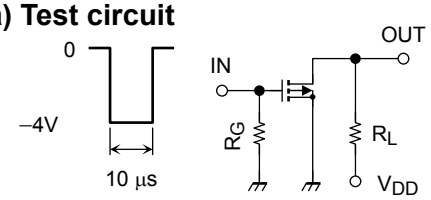
Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Conditions	Min	Typ.	Max	Unit
Drain-Source breakdown voltage		$V_{(BR)\ DSS}$	I_D = −1 mA, V_{GS} = 0	−30	—	—	V
		$V_{(BR)\ DSX}$	I_D = −1 mA, V_{GS} = +20 V	−15	—	—	
Drain cut-off current		I_{DSS}	V_{DS} = −30 V, V_{GS} = 0	—	—	−1	μA
Gate leakage current		I_{GSS}	V_{GS} = ±16V, V_{DS} = 0	—	—	±1	μA
Gate threshold voltage		V_{th}	V_{DS} = −5 V, I_D = −0.1 mA	−0.8	—	−1.8	V
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = −5 V, I_D = − 0.5 A (Note3)	0.5	1.0	—	S
Drain-Source on-resistance		$R_{DS\ (ON)}$	I_D = −0.5 A, V_{GS} = −10 V (Note3)	—	310	390	mΩ
			I_D = −0.5 A, V_{GS} = −4 V (Note3)	—	610	790	
Input capacitance		C_{iss}	V_{DS} = −15 V, V_{GS} = 0, f = 1 MHz	—	86	—	pF
Output capacitance		C_{oss}	V_{DS} = −15 V, V_{GS} = 0, f = 1 MHz	—	25	—	pF
Reverse transfer capacitance		C_{rss}	V_{DS} = −15 V, V_{GS} = 0, f = 1 MHz	—	14	—	pF
Switching time	Turn-on time	t_{on}	V_{DD} = −15 V, I_D = −0.5 A,	—	14	—	ns
	Turn-off time	t_{off}	V_{GS} = 0~−4 V, R_G = 10 Ω	—	8.5	—	
Drain-Source forward voltage		V_{DSF}	I_D = 1.1A, V_{GS} = 0 V (Note3)	—	0.85	1.2	V

Note3: Pulse test

Switching Time Test Circuit

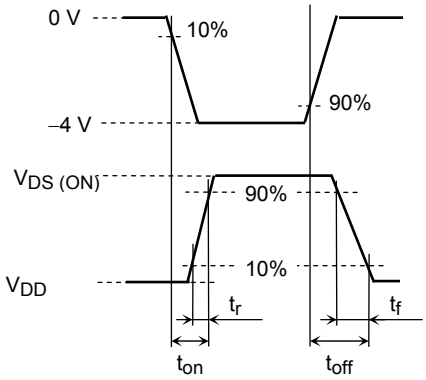
(a) Test circuit



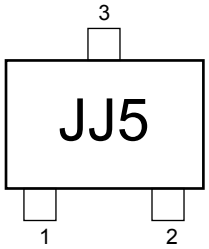
V_{DD} = -10 V
R_G = 4.7 Ω
D.U. ≦ 1%
V_{IN}: t_r, t_f < 5 ns
Common Source
Ta = 25°C

(b) V_{IN}

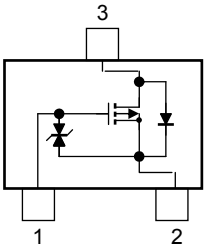
(c) V_{OUT}



Marking



Equivalent Circuit (top view)



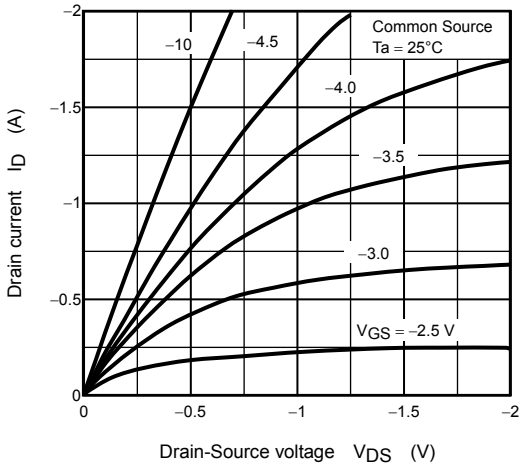
Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D=–0.1mA for this product. For normal switching operation, $V_{GS\ (on)}$ requires a higher voltage than V_{th}, and $V_{GS\ (off)}$ requires a lower voltage than V_{th}.
(The relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$)
Take this into consideration when using the device.

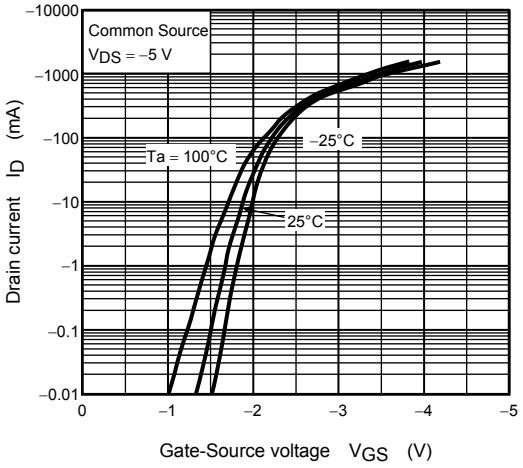
Handling Precaution

When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

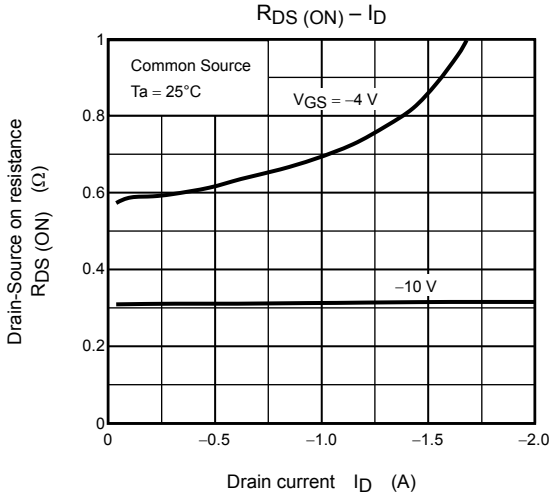
$I_D - V_{DS}$



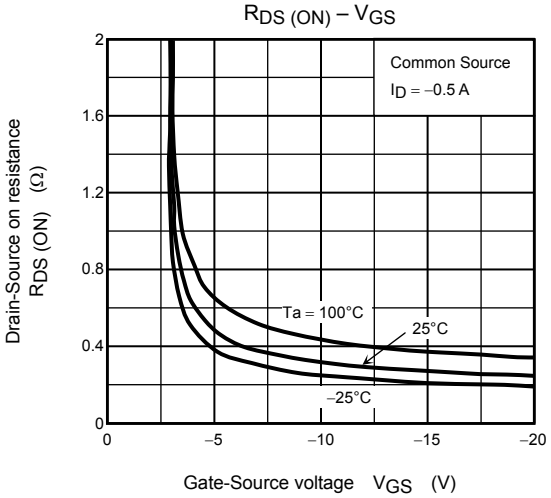
$I_D - V_{GS}$



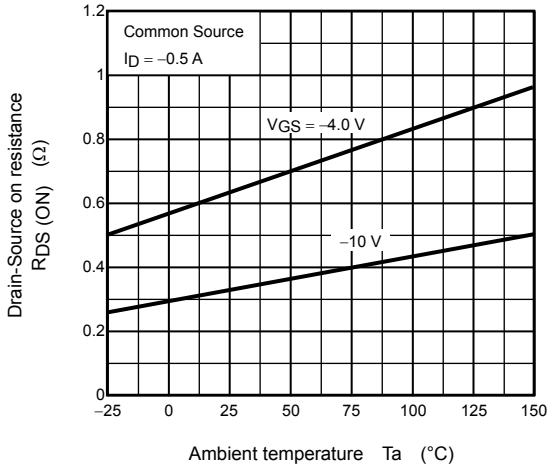
$R_{DS\ (ON)} - I_D$



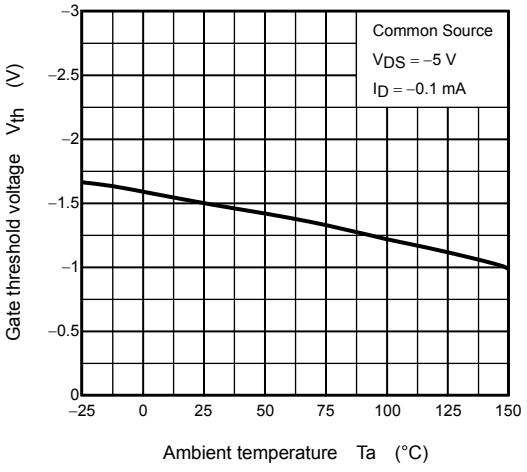
$R_{DS\ (ON)} - V_{GS}$



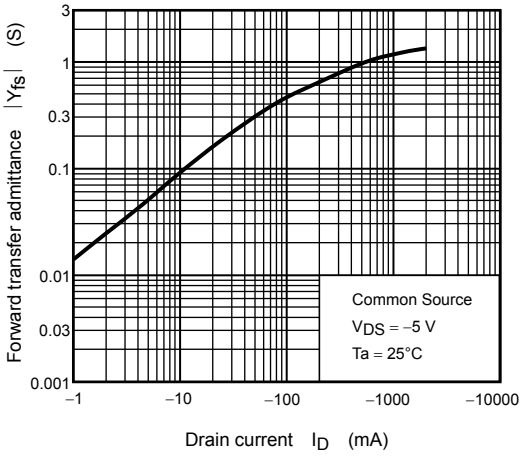
$R_{DS\ (ON)} - Ta$



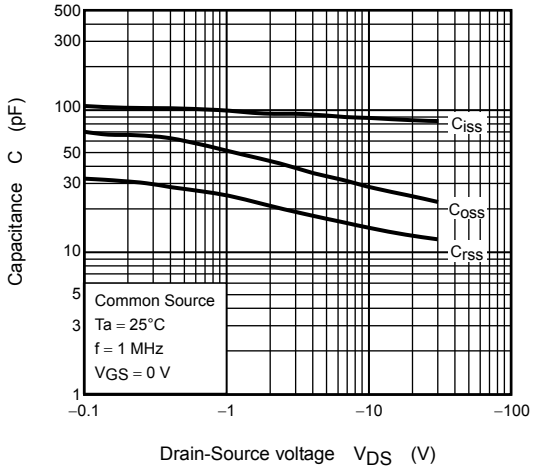
$V_{th} - Ta$



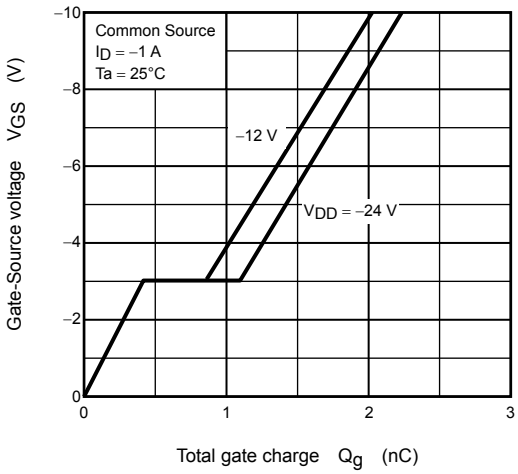
$|Y_{fs}| - I_D$



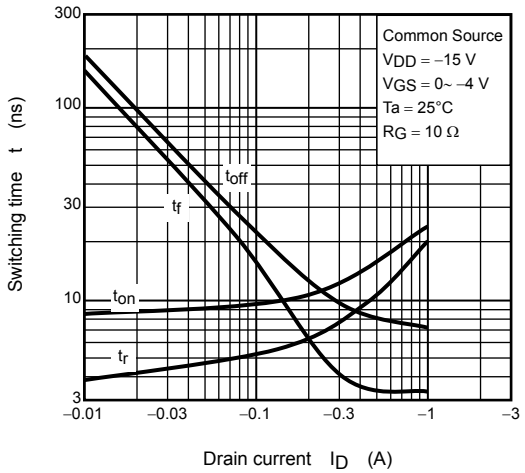
$C - V_{DS}$



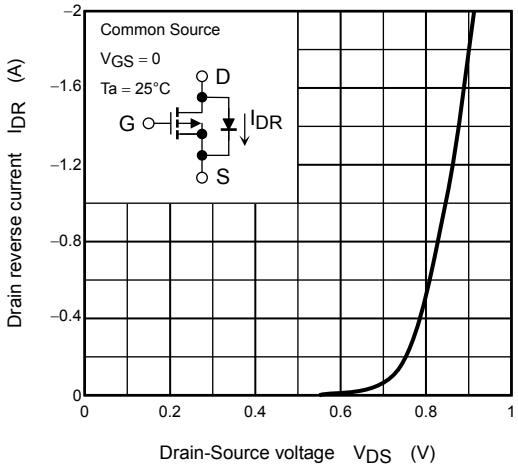
Dynamic input characteristic



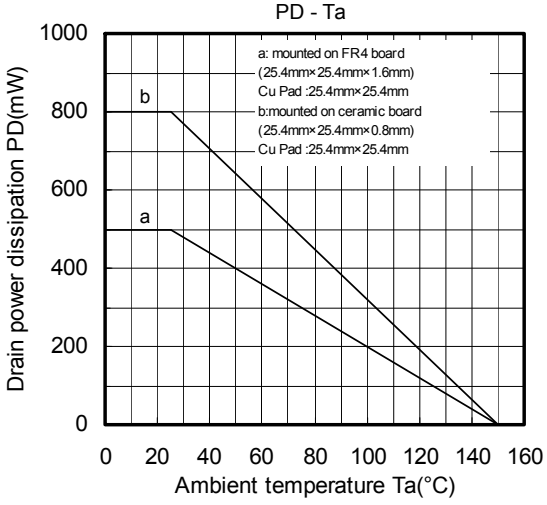
$t - I_D$

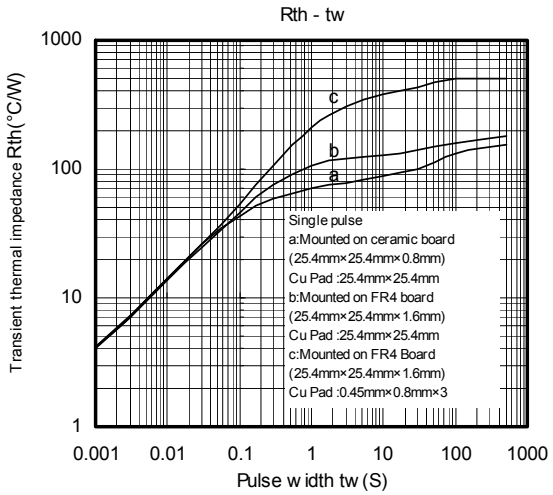


$I_{DR} - V_{DS}$



PD - Ta





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20070701-EN GENERAL

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